

HD74LV2G74A

Single D-type Flip Flops with Preset and Clear

REJ03D0097-0500
(Previous: ADE-205-346D)
Rev.5.00
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Description

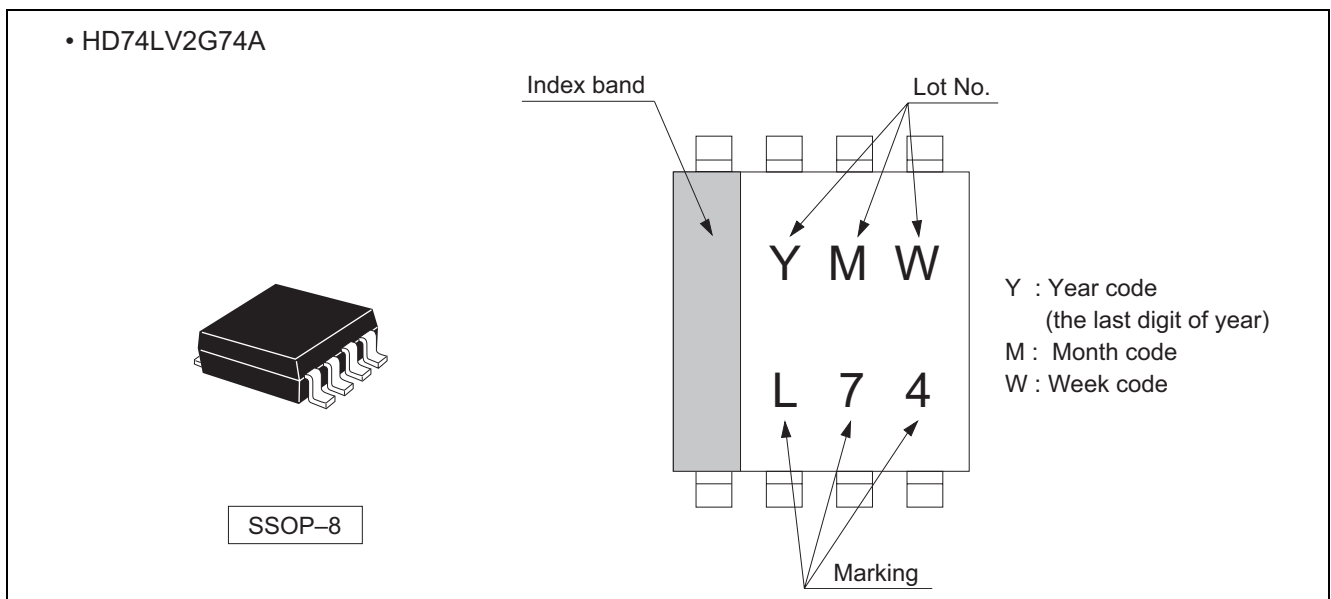
The HD74LV2G74A has independent data, preset, clear, and clock inputs Q and \bar{Q} outputs in an 8 pin package. The input data is transferred to the output at the rising edge of clock pulse CLK. Low voltage and high-speed operation is suitable for the battery powered products (e.g., notebook computers), and the low power consumption extends the battery life.

Features

- The basic gate function is lined up as Renesas uni logic series.
- Supplied on emboss taping for high-speed automatic mounting.
- Electrical characteristics equivalent to the HD74LV74A
Supply voltage range : 1.65 to 5.5 V
Operating temperature range : -40 to +85°C
- All inputs V_{IH} (Max.) = 5.5 V (@ V_{CC} = 0 V to 5.5 V)
All outputs V_O (Max.) = 5.5 V (@ V_{CC} = 0 V)
- Output current ± 6 mA (@ V_{CC} = 3.0 V to 3.6 V), ± 12 mA (@ V_{CC} = 4.5 V to 5.5 V)
- All the logical input has hysteresis voltage for the slow transition.
- Ordering Information

Part Name	Package Type	Package Code (Previous code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LV2G74AUSE	SSOP-8 pin	PVSP0008KA-A (TTP-8DBV)	US	E (3,000 pcs / Reel)

Outline and Article Indication



Function Table

Inputs				Outputs	
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	CLK	D	Q	$\overline{\text{Q}}$
L	H	X	X	H	L
H	L	X	X	L	H
L	L	X	X	H ^{*1}	H ^{*1}
H	H	↑	H	H	L
H	H	↑	L	L	H
H	H	↓	X	Q ₀	$\overline{\text{Q}}$ ₀

H : High level

L : Low level

X : Immaterial

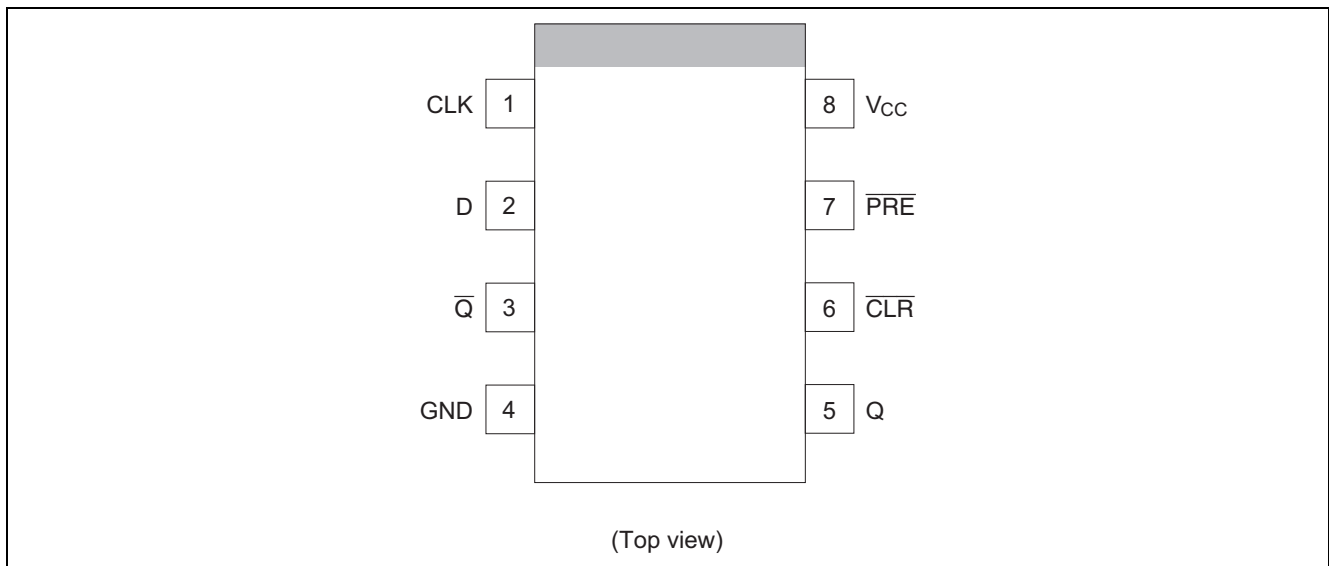
↑ : Low to high transition

↓ : High to low transition

Q₀ : The level of Q immediately before the input conditions shown in the above table are determined.

Note : 1. Q and $\overline{\text{Q}}$ will remain high as long as preset and clear are low, but Q and $\overline{\text{Q}}$ are unpredictable, if preset and clear go high simultaneously.

Pin Arrangement



Absolute Maximum Ratings

Item	Symbol	Ratings	Unit	Test Conditions
Supply voltage range	V_{CC}	-0.5 to 7.0	V	
Input voltage range ^{*1}	V_I	-0.5 to 7.0	V	
Output voltage range ^{*1, 2}	V_O	-0.5 to $V_{CC} + 0.5$	V	Output : H or L
		-0.5 to 7.0		V_{CC} : OFF
Input clamp current	I_{IK}	-20	mA	$V_I < 0$
Output clamp current	I_{OK}	± 50	mA	$V_O < 0$ or $V_O > V_{CC}$
Continuous output current	I_O	± 25	mA	$V_O = 0$ to V_{CC}
Continuous current through V_{CC} or GND	I_{CC} or I_{GND}	± 50	mA	
Maximum power dissipation at $T_a = 25^\circ\text{C}$ (in still air) ^{*3}	P_T	200	mW	
Storage temperature	T_{stg}	-65 to 150	$^\circ\text{C}$	

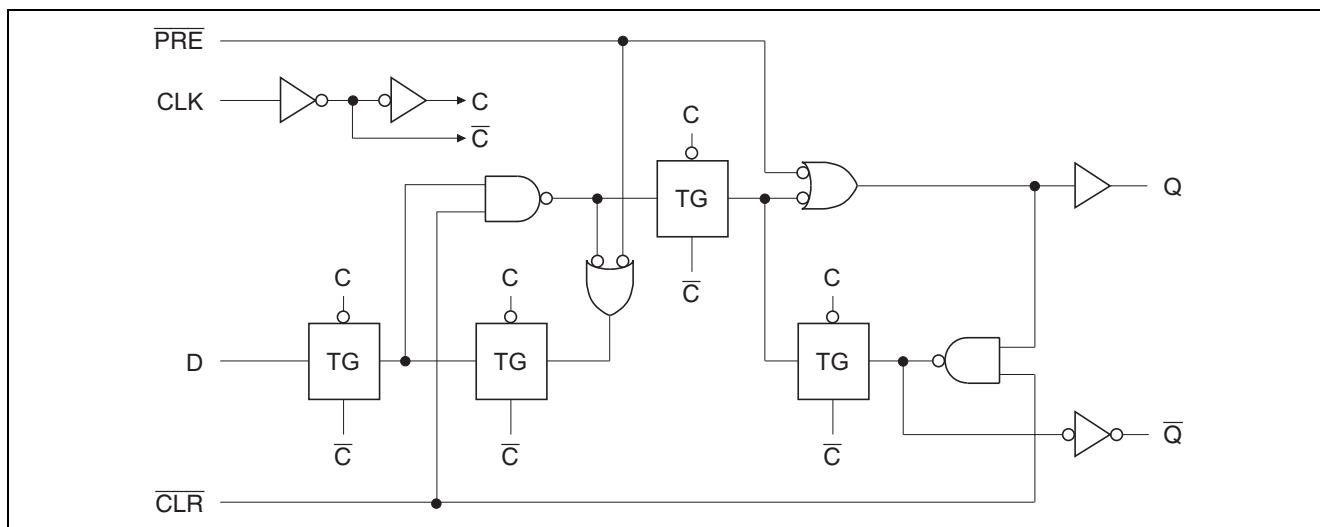
Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore no two of which may be realized at the same time.

1. The input and output voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 5.5 V maximum.
3. The maximum package power dissipation was calculated using a junction temperature of 150°C .

Recommended Operating Conditions

Item	Symbol	Min	Max	Unit	Conditions
Supply voltage range	V_{CC}	1.65	5.5	V	
Input voltage range	V_I	0	5.5	V	
Output voltage range	V_O	0	V_{CC}	V	
Output current	I_{OL}	—	1	mA	$V_{CC} = 1.65$ to 1.95 V
		—	2		$V_{CC} = 2.3$ to 2.7 V
		—	6		$V_{CC} = 3.0$ to 3.6 V
		—	12		$V_{CC} = 4.5$ to 5.5 V
	I_{OH}	—	-1		$V_{CC} = 1.65$ to 1.95 V
		—	-2		$V_{CC} = 2.3$ to 2.7 V
		—	-6		$V_{CC} = 3.0$ to 3.6 V
		—	-12		$V_{CC} = 4.5$ to 5.5 V
Input transition rise or fall rate	$\Delta t / \Delta v$	0	300	ns / V	$V_{CC} = 1.65$ to 1.95 V
		0	200		$V_{CC} = 2.3$ to 2.7 V
		0	100		$V_{CC} = 3.0$ to 3.6 V
		0	20		$V_{CC} = 4.5$ to 5.5 V
Operating free-air temperature	T_a	-40	85	$^\circ\text{C}$	

Note: Unused or floating inputs must be held high or low.

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Logic Diagram

Electrical Characteristics

Ta = -40 to 85°C

Item	Symbol	V _{CC} (V) *	Min	Typ	Max	Unit	Test condition
Input voltage	V _{IH}	1.65 to 1.95	V _{CC} ×0.75	—	—	V	
		2.3 to 2.7	V _{CC} ×0.7	—	—		
		3.0 to 3.6	V _{CC} ×0.7	—	—		
		4.5 to 5.5	V _{CC} ×0.7	—	—		
	V _{IL}	1.65 to 1.95	—	—	V _{CC} ×0.25		
		2.3 to 2.7	—	—	V _{CC} ×0.3		
		3.0 to 3.6	—	—	V _{CC} ×0.3		
		4.5 to 5.5	—	—	V _{CC} ×0.3		
Hysteresis voltage	V _H	1.8	—	0.25	—	V	V _I ⁺ - V _I ⁻
		2.5	—	0.30	—		
		3.3	—	0.35	—		
		5.0	—	0.45	—		
Output voltage	V _{OH}	Min to Max	V _{CC} -0.1	—	—	V	I _{OH} = -50 μA
		1.65	1.4	—	—		I _{OH} = -1 mA
		2.3	2.0	—	—		I _{OH} = -2 mA
		3.0	2.48	—	—		I _{OH} = -6 mA
		4.5	3.8	—	—		I _{OH} = -12 mA
		Min to Max	—	—	0.1		I _{OL} = 50 μA
	V _{OL}	1.65	—	—	0.3		I _{OL} = 1 mA
		2.3	—	—	0.4		I _{OL} = 2 mA
		3.0	—	—	0.44		I _{OL} = 6 mA
		4.5	—	—	0.55		I _{OL} = 12 mA
Input current	I _{IN}	0 to 5.5	—	—	±1	μA	V _{IN} = 5.5 V or GND
Quiescent supply current	I _{CC}	5.5	—	—	10	μA	V _{IN} = V _{CC} or GND, I _O = 0
Output leakage current	I _{OFF}	0	—	—	5	μA	V _{IN} or V _O = 0 to 5.5 V
Input capacitance	C _{IN}	3.3	—	2.5	—	pF	V _{IN} = V _{CC} or GND

Note: For conditions shown as Min or Max, use the appropriate values under recommended operating conditions.

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$V_{CC} = 1.8 \pm 0.15 \text{ V}$

Item	Symbol	T _a = 25°C			T _a = −40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	f _{max}	30	60	—	20	—	MHz	C _L = 15 pF		
		20	40	—	15	—		C _L = 50 pF		
Propagation delay time	t _{PLH}	—	16.3	27.0	1.0	29.0	ns	C _L = 15 pF	PRE/CLR	Q or Q̄
	t _{PHL}	—	17.9	29.0	1.0	32.0			CLK	
		—	21.6	34.0	1.0	36.5		C _L = 50 pF	PRE/CLR	Q or Q̄
		—	24.5	39.5	1.0	42.5			CLK	
Setup time	t _{su}	13.0	—	—	14.0	—	ns		D	
		9.0	—	—	9.0	—			PRE or CLR inactive	
Hold time	t _h	0.5	—	—	0.5	—	ns			
Pulse width	t _w	12.0	—	—	13.0	—	ns		PRE or CLR “L”	
		12.0	—	—	13.0	—			CLK “H” or “L”	

$V_{CC} = 2.5 \pm 0.2 \text{ V}$

Item	Symbol	T _a = 25°C			T _a = −40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	f _{max}	50	100	—	40	—	MHz	C _L = 15 pF		
		30	70	—	25	—		C _L = 50 pF		
Propagation delay time	t _{PLH}	—	9.8	14.8	1.0	17.0	ns	C _L = 15 pF	PRE/CLR	Q or Q̄
	t _{PHL}	—	11.1	16.4	1.0	19.0			CLK	
		—	13.0	17.4	1.0	20.0		C _L = 50 pF	PRE/CLR	Q or Q̄
		—	14.2	20.0	1.0	23.0			CLK	
Setup time	t _{su}	8.0	—	—	9.0	—	ns		D	
		7.0	—	—	7.0	—			PRE or CLR inactive	
Hold time	t _h	0.5	—	—	0.5	—	ns			
Pulse width	t _w	8.0	—	—	9.0	—	ns		PRE or CLR “L”	
		8.0	—	—	9.0	—			CLK “H” or “L”	

$V_{CC} = 3.3 \pm 0.3 \text{ V}$

Item	Symbol	T _a = 25°C			T _a = −40 to 85°C		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	f _{max}	80	140	—	70	—	MHz	C _L = 15 pF		
		50	90	—	45	—		C _L = 50 pF		
Propagation delay time	t _{PLH}	—	6.9	12.3	1.0	14.5	ns	C _L = 15 pF	PRE/CLR	Q or Q̄
	t _{PHL}	—	7.9	11.9	1.0	14.0			CLK	
		—	9.2	15.8	1.0	18.0		C _L = 50 pF	PRE/CLR	Q or Q̄
		—	10.2	15.4	1.0	17.5			CLK	
Setup time	t _{su}	6.0	—	—	7.0	—	ns		D	
		5.0	—	—	5.0	—			PRE or CLR inactive	
Hold time	t _h	0.5	—	—	0.5	—	ns			
Pulse width	t _w	6.0	—	—	7.0	—	ns		PRE or CLR “L”	
		6.0	—	—	7.0	—			CLK “H” or “L”	

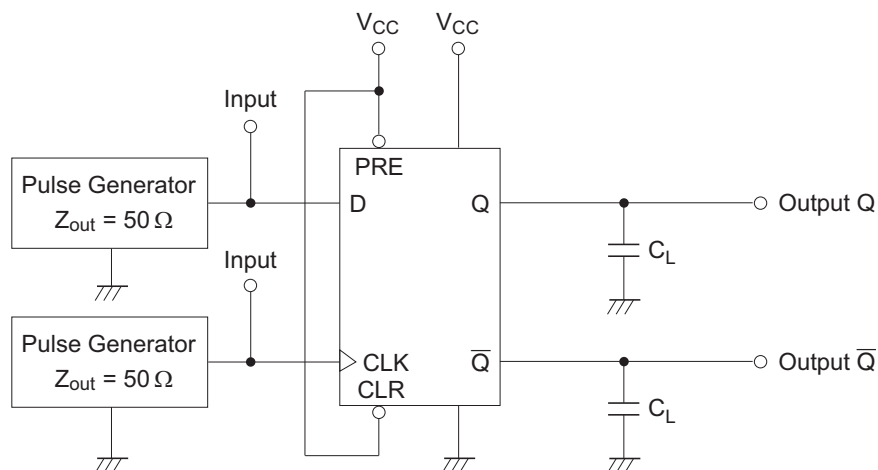
Item	Symbol	$T_a = 25^\circ\text{C}$			$T_a = -40 \text{ to } 85^\circ\text{C}$		Unit	Test Conditions	FROM (Input)	TO (Output)
		Min	Typ	Max	Min	Max				
Maximum clock frequency	f_{\max}	130	180	—	110	—	MHz	$C_L = 15 \text{ pF}$		
		90	140	—	75	—		$C_L = 50 \text{ pF}$		
Propagation delay time	t_{PLH}	—	5.0	7.7	1.0	9.0	ns	$C_L = 15 \text{ pF}$	$\overline{\text{PRE}}/\text{CLR}$	Q or $\overline{\text{Q}}$
	t_{PHL}	—	5.6	7.3	1.0	8.5			CLK	
		—	6.6	9.7	1.0	11.0		$C_L = 50 \text{ pF}$	$\overline{\text{PRE}}/\text{CLR}$	Q or $\overline{\text{Q}}$
		—	7.2	9.3	1.0	10.5			CLK	
Setup time	t_{su}	5.0	—	—	5.0	—	ns		D	
		3.0	—	—	3.0	—			$\overline{\text{PRE}}$ or CLR inactive	
Hold time	t_h	0.5	—	—	0.5	—	ns			
Pulse width	t_w	5.0	—	—	5.0	—	ns		$\overline{\text{PRE}}$ or CLR "L"	
		5.0	—	—	5.0	—			CLK "H" or "L"	

Operating Characteristics

 $C_L = 50 \text{ pF}$

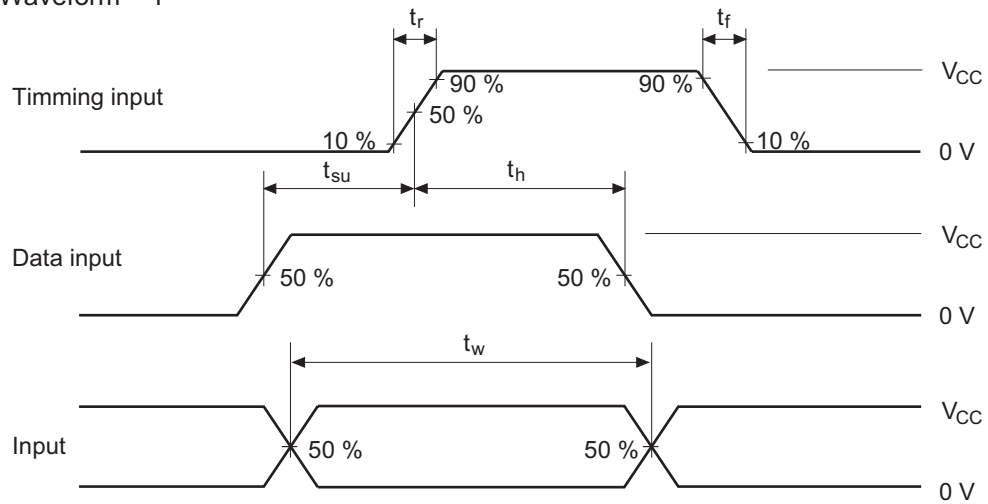
Item	Symbol	$V_{CC} \text{ (V)}$	$T_a = 25^\circ\text{C}$			Unit	Test Conditions
			Min	Typ	Max		
Power dissipation capacitance	C_{PD}	3.3	—	13.0	—	pF	$f = 10 \text{ MHz}$
		5.0	—	14.0	—		

Test Circuit

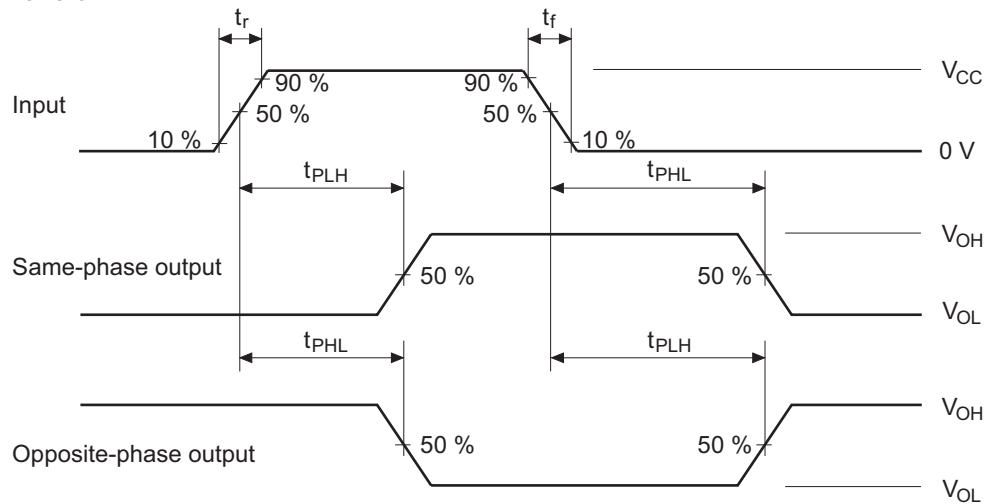


Notes: 1. C_L includes probe and jig capacitance.
2. Test is put into the each flip flops.

• Waveform – 1



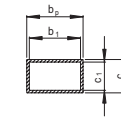
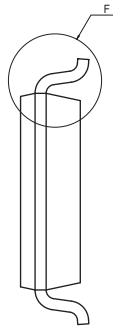
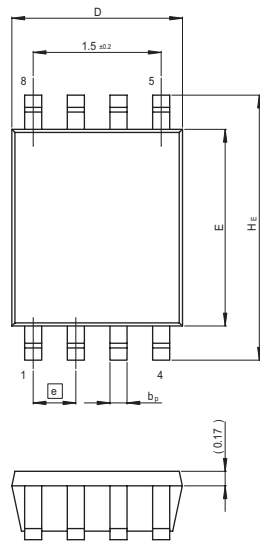
• Waveform – 2



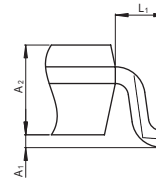
- Notes: 1. Input waveform : $PRR \leq 1 \text{ MHz}$, $Z_o = 50 \Omega$, $t_r \leq 3 \text{ ns}$, $t_f \leq 3 \text{ ns}$.
2. The output are measured one at a time with one transition per measurement.

Package Dimensions

JEITA Package Code	RENESAS Code	Previous Code	MASS[Typ.]
P-VSSOP8-2.3x2-0.50	PVSP0008KA-A	TTP-8DB/TTP-8DBV	0.010g



Terminal cross section



Detail F

Reference Symbol	Dimension in Millimeters		
	Min	Nom	Max
D	1.8	2.0	2.2
E	2.2	2.3	2.4
A ₂	0.6	0.7	0.8
A ₁	0	—	0.1
A	—	—	—
b _P	0.15	0.22	0.3
b ₁	—	0.20	—
c	0.08	0.13	0.23
c ₁	—	0.11	—
θ	—	—	—
H _E	2.8	3.1	3.4
e	—	(0.5)	—
x	—	—	—
y	—	—	—
z	—	—	—
L	—	—	—
L ₁	—	(0.4)	—

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